

PCN: V12-002-476103-OA

Product Change Notice

Issue Date: 22-Mar-2012

Change Type:

Marking process – bottom mark elimination for SOIC devices

Parts Affected:

HCTL-2022
HCTL-2032-SC
HCTL-2032-SCT

Description and Extent of Change:

Lead Type	Current Marking	Proposed Marking	Dummy Proposed Sample Marking
SOM032	TOP  BOTTOM 		
PL020	TOP  BOTTOM 		

Reasons for Change:

To improve cycle time, bottom marking is eliminated for SOIC packages on specific devices.

Effect of Change on Fit, Form, Function, Quality, or Reliability:

There will be no impact to product performance and the changes made are meant for cycle time improvement for marking operation.

Effective Date of Change:

Product shipment using this change will commence from 1-Jun-2012 and may vary depending on depletion of current inventory.

Qualification Data:

The validation data on the above improvements will be shared upon request.

These changes have been reviewed and approved by Avago Technologies engineers and managers per Avago Technologies procedure.

Please contact your Avago Technologies field sales engineer or Contact Center (<http://www.avagotech.com/contact/>) for any questions or support requirements. Please return any response as soon as possible, but not to exceed 30 days.